

FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * Low forward voltage drop

MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Metallurgically bonded construction
- * Polarity: Color band denotes cathode end
- * Mounting position: Any

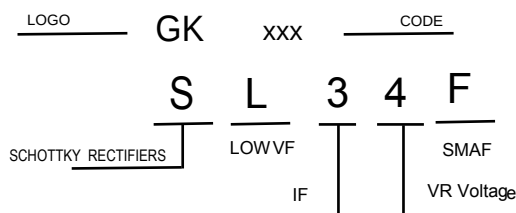


VOLTAGE RANGE

40 Volts

CURRENT

3.0 Ampere



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	SL34F	UNITS
Maximum Recurrent Peak Reverse Voltage	40	V
Maximum RMS Voltage	28	V
Maximum DC Blocking Voltage	40	V
Maximum Average Forward Rectified Current		
See Fig. 1	3.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	80	A
Maximum Instantaneous Forward Voltage at 3.0A	0.41	V
Maximum DC Reverse Current $T_a=25^{\circ}\text{C}$	200	μA
at Rated DC Blocking Voltage $T_a=125^{\circ}\text{C}$	30	mA
Typical Junction Capacitance (Note1)	240	pF
Typical Thermal Resistance R_{JA} (Note 2)	75	$^{\circ}\text{C/W}$
Operating Temperature Range T_j	— -55 to +125 —	$^{\circ}\text{C}$
Storage Temperature Range T_{STG}	-55 to +150	$^{\circ}\text{C}$

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. P.C.B. mounted with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

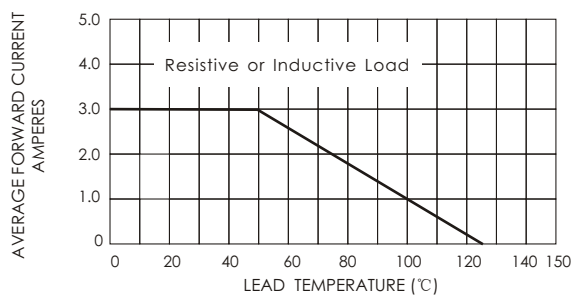


FIG.2-TYPICAL FORWARD CHARACTERISTICS

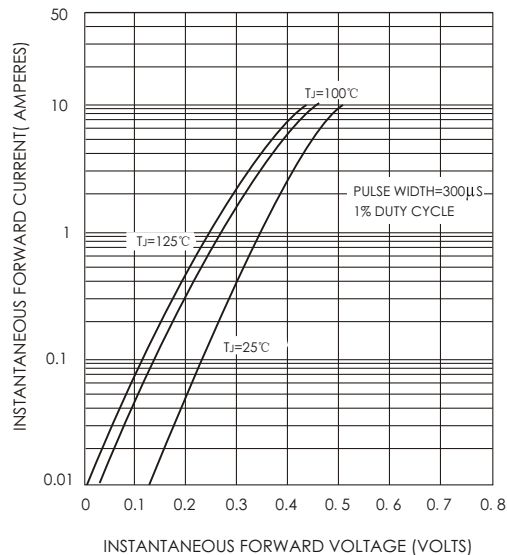


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

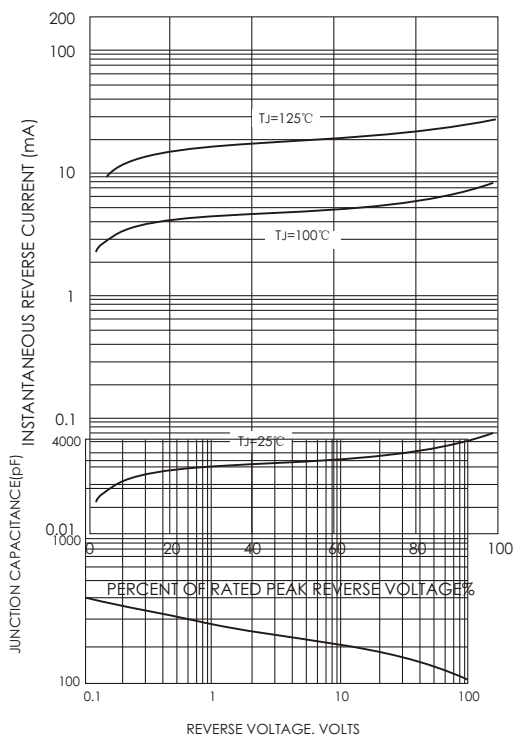


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

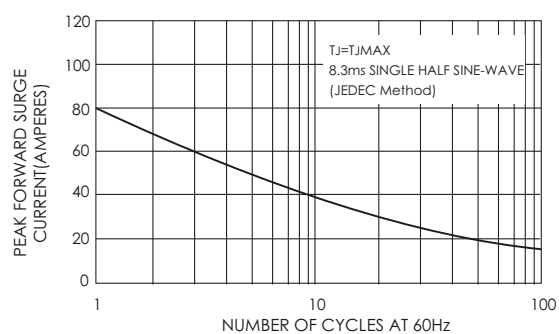
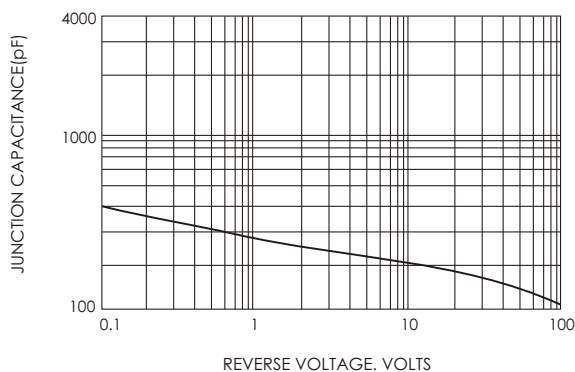
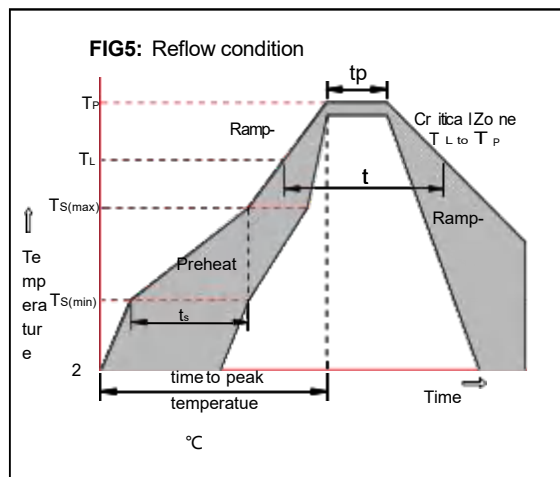


FIG.5-TYPICAL JUNCTION CAPACITANCE



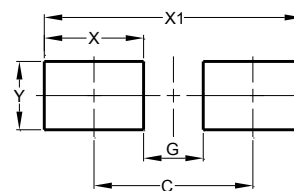
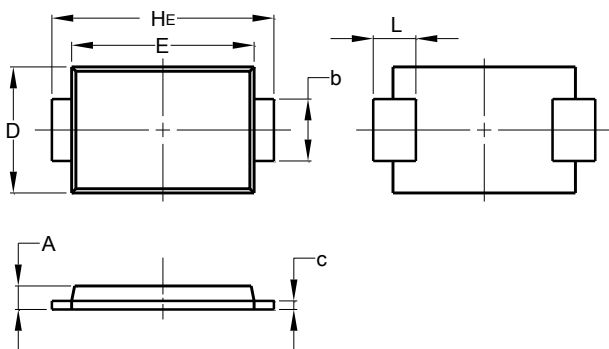
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150 °C
	-Temperature Max ($T_{s(max)}$)	+200 °C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3 °C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3 °C/sec. Max
Reflow	-Temperature (T_L) (Liquid us)	+217 °C
	-Temperature (t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5) °C
Time within 5 °C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6 °C/sec. Max
Time 25 °C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260 °C



Package Dimensions & Suggested Pad Layout

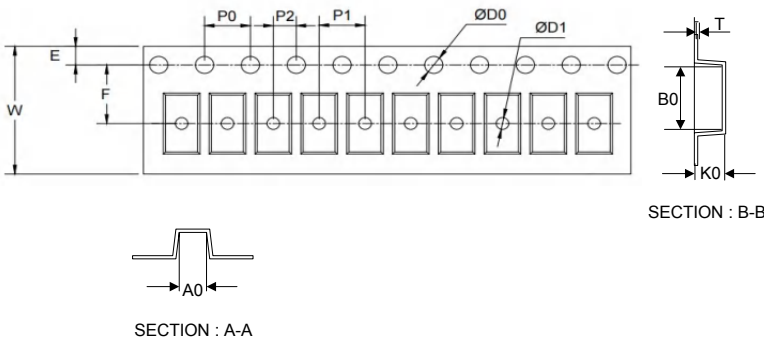
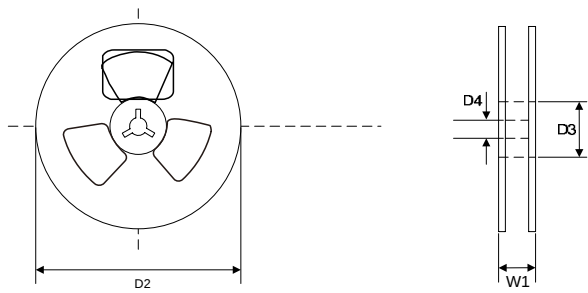
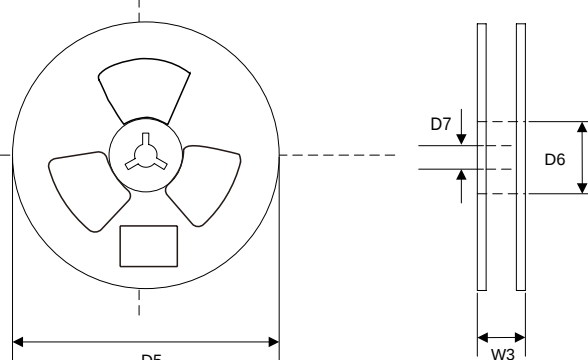
SMAF



SMAF		
Dim	Min	Max
A	0.90	1.20
b	1.30	1.60
c	0.10	0.20
D	2.40	2.70
E	3.30	3.70
H _E	4.40	4.90
L	0.60	1.20
All Dimensions in mm		

Dimensions	Value (in mm)
C	3.80
G	2.20
X	1.60
X1	5.40
Y	1.70

Tape & reel specification

Tape		Symbol	Dimension (mm)
		P0	4.00±0.20
		P1	4.00±0.20
		P2	2.00±0.20
		D0	1.55±0.25
		D1	1.55±0.25
		E	1.75±0.20
		F	5.50±0.20
		W	12.00±0.20
		A0	2.85±0.20
		B0	5.00±0.20
		K0	1.45±0.20
		T	0.26±0.10
		D2	176.0±5.0
		D3	55.0Min.
7" Reel		D4	14.0±2.5
		W1	14.0±2.5
		Quantity: 3000PCS	
13" Reel		D5	330.0±5.0
		D6	73.0Min.
		D7	14.0±2.5
		W2	14.0±2.5
		Quantity: 10000PCS	